

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Sehat Sutardja                      Art Unit : Unknown  
Serial No.: to be assigned                      Examiner : Unknown  
Filed : HEREWITH  
Title : IMPROVED INTEGRATED CHIP PACKAGE HAVING  
INTERMEDIATE SUBSTRATE

JC978 U.S. PTO  
09/966914  
09/27/01

**BOX PATENT APPLICATION**

Commissioner for Patents  
Washington, D.C. 20231

INFORMATION DISCLOSURE STATEMENT

Applicant submits the references listed on the attached  
form PTO-1449, copies of which are enclosed.

This statement is being filed with the application. Please  
apply any charges or credits to Deposit Account No. 06-1050.

Respectfully submitted,

Date: 9/27/01

Joseph L. Stevenson  
Joseph L. Stevenson  
Reg. No. 43,163

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CERTIFICATE OF MAILING BY EXPRESS MAIL

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